

Features

- ESD Protected Up To 2KV (HBM)
- High Density Cell Design For Low R_{DS(ON)}
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note1)
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

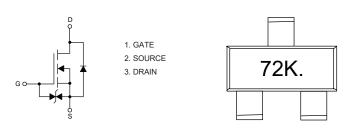
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Thermal Resistance: 379°C/W Junction to Ambient^(Note2)

Parameter	Symbol	Rating	Unit		
Drain-Source Voltage	V _{DS}	60	V		
Gate-Source Volltage		V _{GS}	±20	V	
Continuous Drain Current	T _A =25°C		0.34	A	
	T _A =100°C	l _D	0.22		
Pulsed Drain Current ^(Note3)		I _{DM}	1.4	Α	
Total Power Dissipation ^(Note4)		P _D	0.33	W	

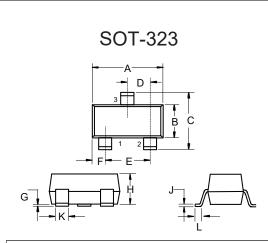
Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code

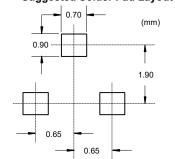


N-Channel MOSFET



DIMENSIONS					
DIM	INC	HES	MM		NOTE
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.083	0.096	2.10	2.45	
D	0.026		0.65		TYP.
E	0.047	0.055	1.20	1.40	
F	0.012	0.016	0.30	0.40	
G	0.000	0.004	0.00	0.10	
Н	0.035	0.044	0.90	1.10	
J	0.002	0.010	0.05	0.25	
K	0.006	0.016	0.15	0.40	
L	0.010	0.018	0.26	0.46	

Suggested Solder Pad Layout





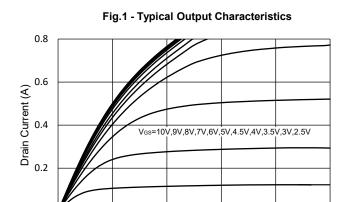
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics				1			
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V _{GS} =0V, I _D =250μA	60			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±10	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =48V, V _{GS} =0V			1	μA	
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =1mA	1.0	1.5	2.0	V	
Drain Source On Resistance	Б	V _{GS} =10V, I _D =500mA		1.8	2.5	Ω	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =200mA		2.0	3.0		
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =200mA		300		mS	
Gate Resistance	R _g	f=1 MHz, Open drain		100		Ω	
Diode Characteristics							
Continuous Body Diode Current	Is				0.34	А	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =300mA			1.2	V	
Reverse Recovery Time	t _{rr}	1 =0 3A dl /dt=100A/up		10		ns	
Reverse Recovery Charge	Q _{rr}	I _F =0.3A, dI _F /dt=100A/μs		2.6		nC	
Dynamic Characteristics							
Input Capacitance	C _{iss}			15			
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V,f=1MHz		3		pF	
Reverse Transfer Capacitance	C _{rss}			2			
Total Gate Charge	Q_g			0.9			
Gate-Source Charge	Q _{gs}	V _{DS} =30V,V _{GS} =10V,I _D =0.3A		0.15		nC	
Gate-Drain Charge	Q_{gd}			0.25			
Turn-On Delay Time	t _{d(on)}			3			
Turn-On Rise Time	t _r	V _{DD} =50V, V _{GS} =10V		3.8		F	
Turn-Off Delay Time	t _{d(off)}	, R_G =50Ω, I_D =0.3A		10		ns	
Turn-Off Fall Time	t _f			30			



Curve Characteristics

0.0 0

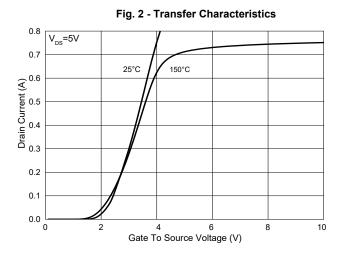


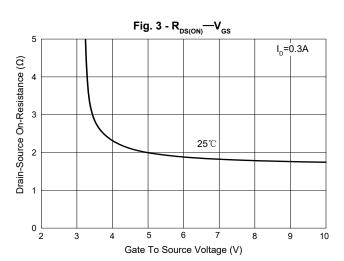
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3

Drain To Source Voltage (V)

1





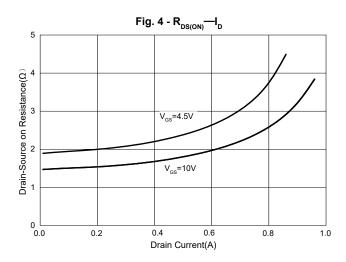
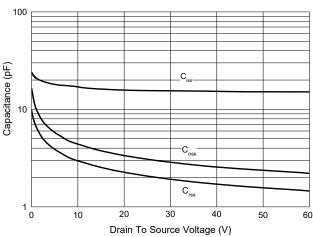
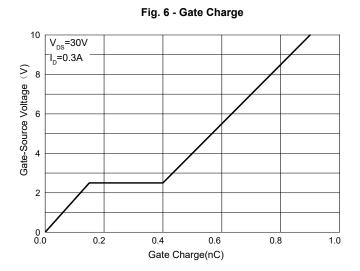


Fig. 5 - Capacitance Characteristics



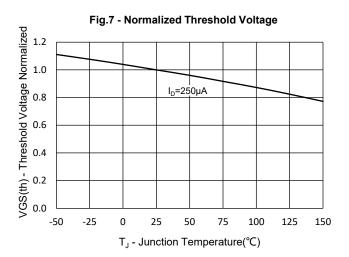


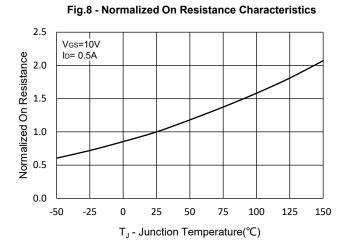
5

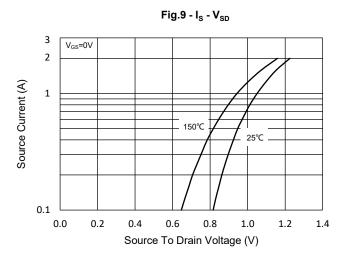
4

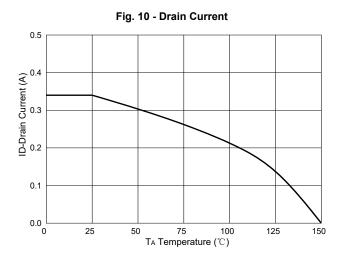


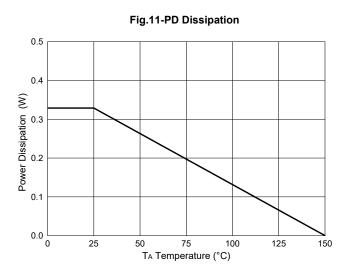
Curve Characteristics





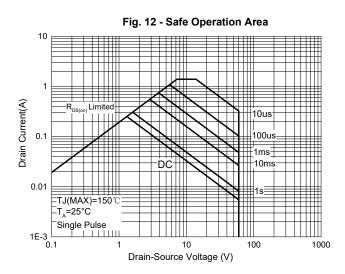


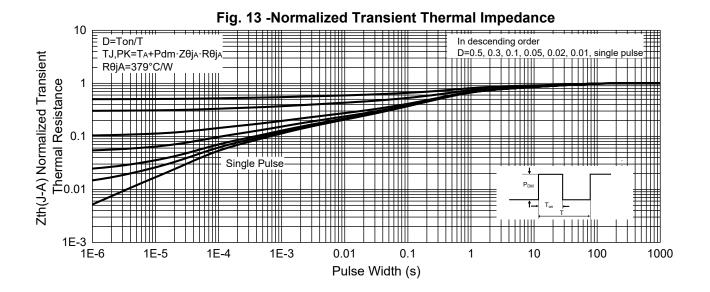






Curve Characteristics







Ordering Information

Device	Packing	
Part Number-TP	Tape&Reel: 3Kpcs/Reel	
Part Number-13P	Tape&Reel: 10Kpcs/Reel	

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